

# **NPN Silicon Power Darlington Transistors**

The MJE5740 and MJE5742 Darlington transistors are designed for high-voltage power switching in inductive circuits. They are particularly suited for operation in applications such as:

- Small Engine Ignition
- Switching Regulators
- Inverters
- Solenoid and Relay Drivers
- Motor Controls

### **MAXIMUM RATINGS**

| Rating  | Symbol                            | MJE5740     | MJE5742 | Unit           |  |     |
|---|-----------------------------------|-------------|---------|----------------|--|-----|
| Collector–Emitter Voltage   | V <sub>CEO(sus)</sub>             | 300         | 400     | Vdc            |  |     |
| Collector–Emitter Voltage   | V <sub>CEV</sub>                  | 600         | 800     | Vdc            |  |     |
| Emitter Base Voltage  | V <sub>EB</sub>                   | 8           |         | Vdc            |  |     |
| Collector Current – Continuous<br>– Peak (1)                        | I <sub>C</sub>                    | 8<br>16     |         | -              |  | Adc |
| Base Current - Continuous<br>- Peak (1)                             | I <sub>B</sub><br>I <sub>BM</sub> | 2.5<br>5    |         | Adc            |  |     |
| Total Power Dissipation  @ T <sub>A</sub> = 25°C  Derate above 25°C | P <sub>D</sub>                    | 2<br>16     |         | Watts<br>mW/°C |  |     |
| Total Power Dissipation  @ T <sub>C</sub> = 25°C  Derate above 25°C | P <sub>D</sub>                    | 80<br>640   |         | Watts<br>mW/°C |  |     |
| Operating and Storage Junction Temperature Range                    | T <sub>J</sub> , T <sub>stg</sub> | -65 to +150 |         | °C             |  |     |

(1) Pulse Test: Pulse Width = 5 ms, Duty Cycle = 10%.

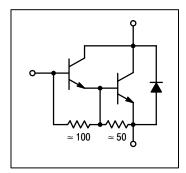
#### THERMAL CHARACTERISTICS

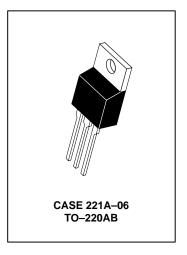
| Characteristic  | Symbol         | Max  | Unit |  |  |  |
|---|----------------|------|------|--|--|--|
| Thermal Resistance, Junction to Case  | $R_{	heta JC}$ | 1.56 | °C/W |  |  |  |
| Thermal Resistance, Junction to Ambient                                       | $R_{	heta JA}$ | 62.5 | °C/W |  |  |  |
| Maximum Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds | TL             | 275  | °C   |  |  |  |

# **MJE5740 MJE5742\***

\*ON Semiconductor Preferred Device

**POWER DARLINGTON TRANSISTORS 8 AMPERES** 300, 400 VOLTS 80 WATTS





Preferred devices are ON Semiconductor recommended choices for future use and best overall value.

### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Base–Emitter Saturation Voltage (I<sub>C</sub> = 4 Adc, I<sub>B</sub> = 0.2 Adc) (I<sub>C</sub> = 8 Adc, I<sub>B</sub> = 0.4 Adc) (I<sub>C</sub> = 4 Adc, I<sub>B</sub> = 0.2 Adc, T<sub>C</sub> = 100 $^{\circ}$ C)

| Characteristic  |                      | Min          | Тур         | мах           | Unit |
|---|----------------------|--------------|-------------|---------------|------|
| OFF CHARACTERISTICS (2)   |                      | •            |             |               |      |
| Collector–Emitter Sustaining Voltage MJE57 $(I_C = 50 \text{ mA}, I_B = 0)$ MJE57   | 000(303)             | 300<br>400   | _<br>_      | _<br>_        | Vdc  |
| Collector Cutoff Current ( $V_{CEV}$ = Rated Value, $V_{BE(off)}$ = 1.5 Vdc) ( $V_{CEV}$ = Rated Value, $V_{BE(off)}$ = 1.5 Vdc, $T_C$ = 100°C)           | I <sub>CEV</sub>     | _<br>_       | _<br>_      | 1<br>5        | mAdc |
| Emitter Cutoff Current (V <sub>EB</sub> = 8 Vdc, I <sub>C</sub> = 0)  | I <sub>EBO</sub>     | -            | -           | 75            | mAdc |
| SECOND BREAKDOWN  |                      |              |             |               |      |
| Second Breakdown Collector Current with Base Forward Biased   |                      | See Figure 6 |             |               |      |
| Clamped Inductive SOA with Base Reverse Biased  | RBSOA                | See Figure 7 |             |               |      |
| Characteristic  | Symbol               | Min          | Тур         | Max           | Unit |
| ON CHARACTERISTICS (3)  |                      |              |             |               |      |
| DC Current Gain ( $I_C = 0.5 \text{ Adc}$ , $V_{CE} = 5 \text{ Vdc}$ )<br>( $I_C = 4 \text{ Adc}$ , $V_{CE} = 5 \text{ Vdc}$ )                            | h <sub>FE</sub>      | 50<br>200    | 100<br>400  | _<br>_        | _    |
| Collector–Emitter Saturation Voltage ( $I_C$ = 4 Adc, $I_B$ = 0.2 Adc) ( $I_C$ = 8 Adc, $I_B$ = 0.4 Adc) ( $I_C$ = 4 Adc, $I_B$ = 0.2 Adc, $I_C$ = 100°C) | V <sub>CE(sat)</sub> | -<br>-<br>-  | -<br>-<br>- | 2<br>3<br>2.2 | Vdc  |

#### **SWITCHING CHARACTERISTICS**

Diode Forward Voltage (4) (I<sub>F</sub> = 5 Adc)

| Typical Resistive Load (Table 1)  |   |                 |   |      |   |    |
|-----------------------------------|---|-----------------|---|------|---|----|
| Delay Time                        |   | t <sub>d</sub>  | - | 0.04 | - | μs |
| Rise Time                         | $(V_{CC} = 250 \text{ Vdc}, I_{C(pk)} = 6 \text{ A}$<br>$I_{B1} = I_{B2} = 0.25 \text{ A}, t_p = 25 \mu s,$         | t <sub>r</sub>  | - | 0.5  | - | μs |
| Storage Time                      | i <sub>B1</sub> = i <sub>B2</sub> = 0.25 A, i <sub>p</sub> = 25 μs,<br>  Duty Cycle ≤ 1%)                           | t <sub>s</sub>  | - | 8    | - | μs |
| Fall Time                         |   | t <sub>f</sub>  | - | 2    | - | μs |
| Inductive Load, Clamped (Table 1) |   |                 |   |      |   |    |
| Voltage Storage Time              | $(I_{C(pk)} = 6 \text{ A}, V_{CF(pk)} = 250 \text{ Vdc}$  | t <sub>sv</sub> | _ | 4    | - | μs |
| Crossover Time                    | $(I_{C(pk)} = 6 \text{ A}, V_{CE(pk)} = 250 \text{ Vdc}$<br>$I_{B1} = 0.06 \text{ A}, V_{BE(off)} = 5 \text{ Vdc})$ | t <sub>c</sub>  | - | 2    | - | μs |

 $V_{BE(sat)}$ 

 $V_{f}$ 

\_

Vdc

Vdc

2.5

3.5 2.4

2.5

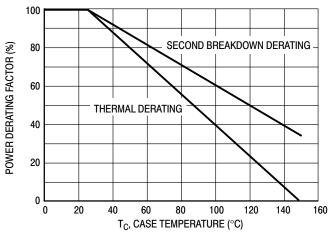
<sup>(2)</sup> Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle = 2%.

<sup>(</sup>continued)

<sup>(3)</sup> Pulse Test: Pulse Width 300  $\mu$ s, Duty Cycle = 2%.

<sup>(4)</sup> The internal Collector–to–Emitter diode can eliminate the need for an external diode to clamp inductive loads. Tests have shown that the Forward Recovery Voltage (V<sub>f</sub>) of this diode is comparable to that of typical fast recovery rectifiers.

#### **TYPICAL CHARACTERISTICS**



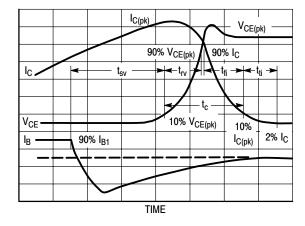
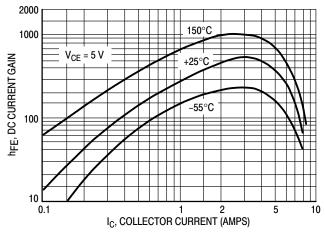


Figure 1. Power Derating

**Figure 2. Inductive Switching Measurements** 





2.4

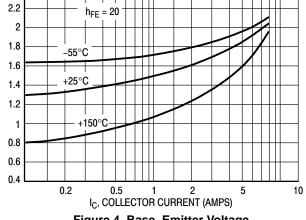
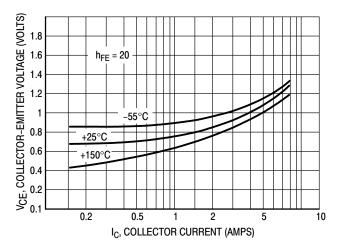


Figure 3. DC Current Gain

Figure 4. Base-Emitter Voltage

**Table 1. Test Conditions for Dynamic Performance** 

|                | REVERSE BIAS SAFE OPERATING AREA AND INDUCTIVE SWITCHING   | RESISTIVE<br>SWITCHING  |
|----------------|--|---|
| TEST CIRCUITS  | DUTY CYCLE $\leq$ 10% $_{1}^{4}$ $\leq$ 10 ns $_{1}^{4}$ | +V <sub>CC</sub> R <sub>C</sub> TUT  SCOPE  1  -4 V   |
| CIRCUIT        | COIL DATA: GAP FOR 200 $\mu$ H/20 A FERROXCUBE CORE #6656 FULL BOBBIN (~16 TURNS) #16 CORE $\mu$ H/20 A $\mu$ H/20 A $\mu$ CC = 30 V $\mu$ CE( $\mu$ k) = 250 Vdc $\mu$ CE( $\mu$ k) = 6 A   | V <sub>CC</sub> = 250 V<br>D1 = 1N5820 OR EQUIV.  |
| TEST WAVEFORMS | OUTPUT WAVEFORMS $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$  | +10 V 25 μs  0 -9.2 V 2  t <sub>p</sub> , t <sub>f</sub> < 10 ns DUTY CYCLE = 1% R <sub>B</sub> AND R <sub>C</sub> ADJUSTED FOR DESIRED I <sub>B</sub> AND I <sub>C</sub> |



**Figure 5. Inductive Switching Measurements** 

#### SAFE OPERATING AREA INFORMATION

#### **FORWARD BIAS**

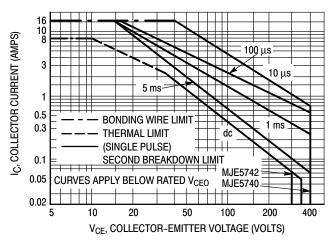
There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate  $I_C - V_{CE}$  limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 6 is based on  $T_C = 25\,^{\circ}C$ ;  $T_{J(pk)}$  is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to 10% but must be derated when  $T_C \ge 25\,^{\circ}C$ . Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown on Figure 6 may be found at any case temperature by using the appropriate curve on Figure 1.

#### **REVERSE BIAS**

For inductive loads, high voltage and high current must be sustained simultaneously during turn-off, in most cases, with the base to emitter junction reverse biased. Under these conditions the collector voltage must be held to a safe level at or below a specific value of collector current. This can be accomplished by several means such as active clamping, RC snubbing, load line shaping, etc. The safe level for these devices is specified as Reverse Bias Safe Operating Area and represents the voltage-current condition allowable during reverse biased turnoff. This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode. Figure 7 gives the complete RBSOA characteristics.

The Safe Operating Area figures shown in Figures 6 and 7 are specified ratings for these devices under the test conditions shown.



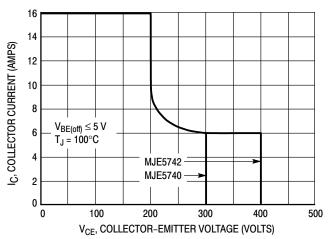


Figure 6. Forward Bias Safe Operating Area

Figure 7. Reverse Bias Safe Operating Area

#### RESISTIVE SWITCHING PERFORMANCE

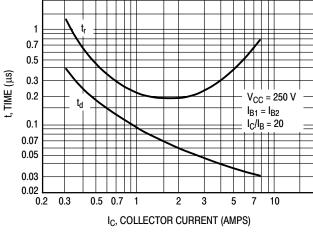


Figure 8. Turn-On Time

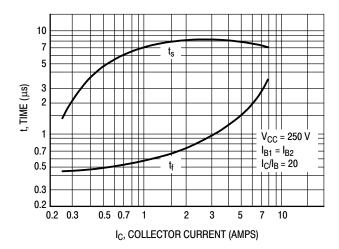
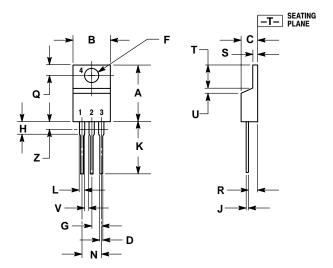


Figure 9. Turn-Off Time

### **PACKAGE DIMENSIONS**

#### TO-220AA **CASE 221A-09 ISSUE AA**



- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
  3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

|     | INCHES |       | MILLIMETERS |       |
|-----|--------|-------|-------------|-------|
| DIM | MIN    | MAX   | MIN MAX     |       |
| Α   | 0.570  | 0.620 | 14.48       | 15.75 |
| В   | 0.380  | 0.405 | 9.66        | 10.28 |
| С   | 0.160  | 0.190 | 4.07        | 4.82  |
| D   | 0.025  | 0.035 | 0.64        | 0.88  |
| F   | 0.142  | 0.147 | 3.61        | 3.73  |
| G   | 0.095  | 0.105 | 2.42        | 2.66  |
| Н   | 0.110  | 0.155 | 2.80        | 3.93  |
| J   | 0.018  | 0.025 | 0.46        | 0.64  |
| K   | 0.500  | 0.562 | 12.70       | 14.27 |
| L   | 0.045  | 0.060 | 1.15        | 1.52  |
| N   | 0.190  | 0.210 | 4.83        | 5.33  |
| Q   | 0.100  | 0.120 | 2.54        | 3.04  |
| R   | 0.080  | 0.110 | 2.04        | 2.79  |
| S   | 0.045  | 0.055 | 1.15        | 1.39  |
| T   | 0.235  | 0.255 | 5.97        | 6.47  |
| U   | 0.000  | 0.050 | 0.00 1.27   |       |
| ٧   | 0.045  |       | 1.15        |       |
| Z   |        | 0.080 |             | 2.04  |



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